

# P-Channel 100 V (D-S) MOSFET

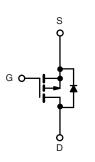
PRODUCT	ODUCT SUMMARY				
V <sub>DS</sub> (V)	<b>R<sub>DS(on)</sub> (Ω)</b>	I <sub>D</sub> (A)	Q <sub>g</sub> (Typ.)		
- 100	0.215 at $V_{GS}$ = - 10 V	- 12	11		
- 100	0.234 at V <sub>GS</sub> = - 4.5 V	- 10	11		

#### **FEATURES**

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET<sup>®</sup> Power MOSFET ٠
- 100 % R<sub>g</sub> and UIS Tested
  Compliant to RoHS Directive 2002/95/EC

#### **APPLICATIONS**

- Power Switch
- DC/DC Converters



P-Channel MOSFET

<b>ABSOLUTE MAXIMUM RATINGS</b>	T <sub>C</sub> = 25 °C, unless oth	erwise noted		
Parameter		Symbol	Limit	Unit
Drain-Source Voltage		V <sub>DS</sub>	- 100	v
Gate-Source Voltage		V <sub>GS</sub>	± 20	v
Continuous Drain Current ( $T_J = 150 \ ^{\circ}C$ )	T <sub>C</sub> = 25 °C	1-	- 12	
	T <sub>C</sub> = 70 °C	I <sub>D</sub>	- 8	A
Pulsed Drain Current		I <sub>DM</sub>	- 30	A
Avalanche Current		I <sub>AS</sub>	- 20	
Single Avalanche Energy <sup>a</sup>	L = 0.1 mH	E <sub>AS</sub>	16.2	mJ
	T <sub>C</sub> = 25 °C	P	32.1 <sup>b</sup>	14/
Maximum Power Dissipation <sup>a</sup>	T <sub>A</sub> = 25 °C <sup>c</sup>	– P <sub>D</sub> –	2.5	W
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C

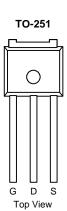
THERMAL RESISTANCE RATINGS			
Parameter	Symbol	Limit	Unit
Junction-to-Ambient (PCB Mount) <sup>c</sup>	R <sub>thJA</sub>	50	°C/W
Junction-to-Case (Drain)	R <sub>thJC</sub>	3.9	0/11

Notes:

a. Duty cycle  $\leq$  1 %.

b. See SOA curve for voltage derating.

c. When Mounted on 1" square PCB (FR-4 material).





COMPLIANT HALOGEN FREE

B <sup>®</sup> VBsemi
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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static		·				
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{DS} = 0 V, I_D = -250 \mu A$	- 100			v
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$	- 1		- 2.5	v
Gate-Body Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 250	nA
		$V_{DS} = -100 \text{ V}, V_{GS} = 0 \text{ V}$			- 1	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS}$ = - 100 V, $V_{GS}$ = 0 V, $T_{J}$ = 125 °C			- 50	μA
		$V_{DS} = -100 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{\text{J}} = 150 ^{\circ}\text{C}$			- 250	1
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \le$ - 10 V, $V_{GS}$ = - 10 V	- 15			А
	D	V <sub>GS</sub> = - 10 V, I <sub>D</sub> = - 3.6 A		0.215		0
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = - 4.5 V, I <sub>D</sub> = - 3.4 A		0.234		Ω
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = - 15 V, I <sub>D</sub> = - 3.6 A		12		S
Dynamic <sup>b</sup>	•	·				
Input Capacitance	C <sub>iss</sub>			1055		
Output Capacitance	C <sub>oss</sub>	V <sub>GS</sub> = 0 V, V <sub>DS</sub> = - 50 V, f = 1 MHz		65		pF
Reverse Transfer Capacitance	C <sub>rss</sub>			41		
Tatal Cata Charge <sup>C</sup>	Qg	$V_{DS} = -50 \text{ V}, V_{GS} = -10 \text{ V}, I_{D} = -3.6 \text{ A}$		23		
Total Gate Charge <sup>c</sup>	۹g			11		nC
Gate-Source Charge <sup>c</sup>	Q <sub>gs</sub>	$V_{DS}$ = - 50 V, $V_{GS}$ = - 4.5 V, $I_{D}$ = - 3.6 A		3.5		no
Gate-Drain Charge <sup>c</sup>	Q <sub>gd</sub>			4.8		
Gate Resistance	R <sub>g</sub>	f = 1 MHz	1.2	5.7	11.5	Ω
Turn-On Delay Time <sup>c</sup>	t <sub>d(on)</sub>			7	14	
Rise Time <sup>c</sup>	t <sub>r</sub>	$V_{DD}$ = - 50 V, $R_L$ = 17.2 $\Omega$		12	18	ns
Turn-Off Delay Time <sup>c</sup>	t <sub>d(off)</sub>	$I_D \cong$ - 2.9 A, $V_{GEN}$ = - 10 V, $R_g$ = 1 $\Omega$		33	50	115
Fall Time <sup>c</sup>	t <sub>f</sub>			9	18	
Drain-Source Body Diode Ratings and	nd Characteri	stics T <sub>C</sub> = 25 °C <sup>b</sup>				
Continuous Current	۱ <sub>S</sub>				- 8.8	^
Pulsed Current	I <sub>SM</sub>				- 15	A
Forward Voltage <sup>a</sup>	V <sub>SD</sub>	$I_{F} = -2.9 \text{ A}, V_{GS} = 0 \text{ V}$		- 0.8	- 1.5	V
Reverse Recovery Time	t <sub>rr</sub>			50	75	ns
Peak Reverse Recovery Current	I <sub>RM(REC)</sub>	I <sub>F</sub> = - 2.9 A, dl/dt = 100 A/μs		- 4	- 6	Α
Reverse Recovery Charge	Q <sub>rr</sub>	1 1		98	147	nC

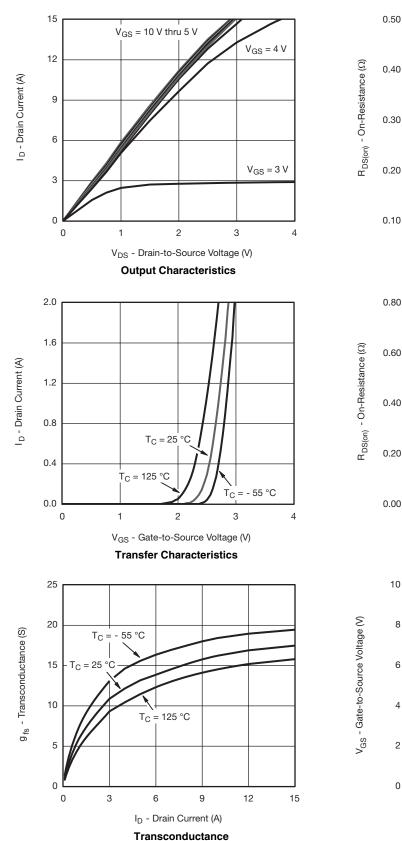
Notes:

a. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %.

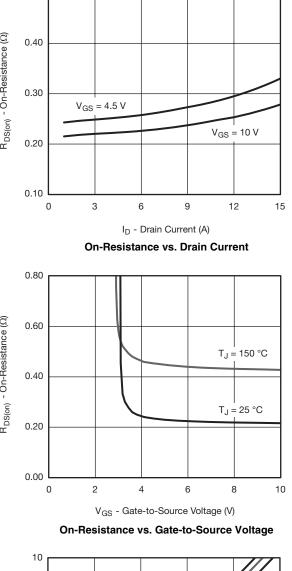
b. Guaranteed by design, not subject to production testing.c. Independent of operating temperature.

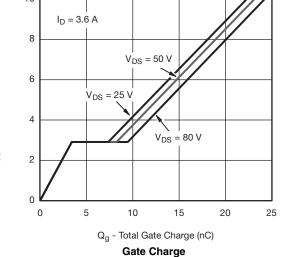
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.





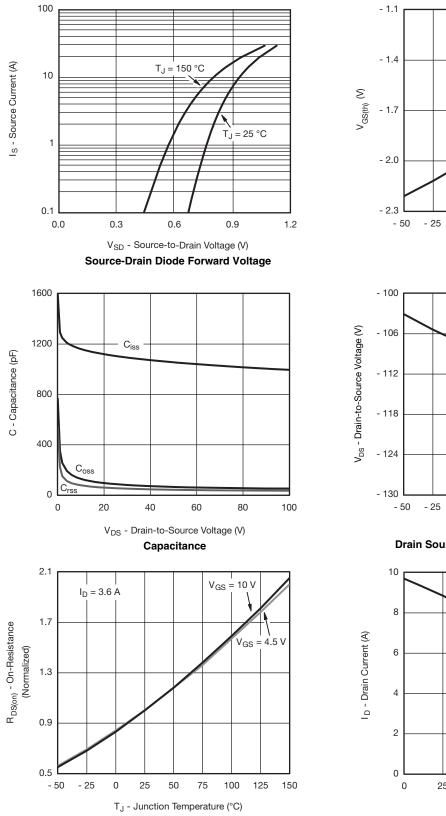
#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



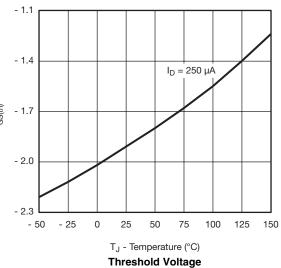


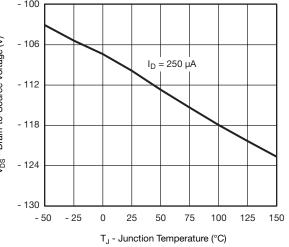


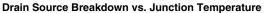
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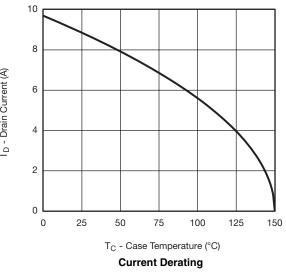


On-Resistance vs. Junction Temperature



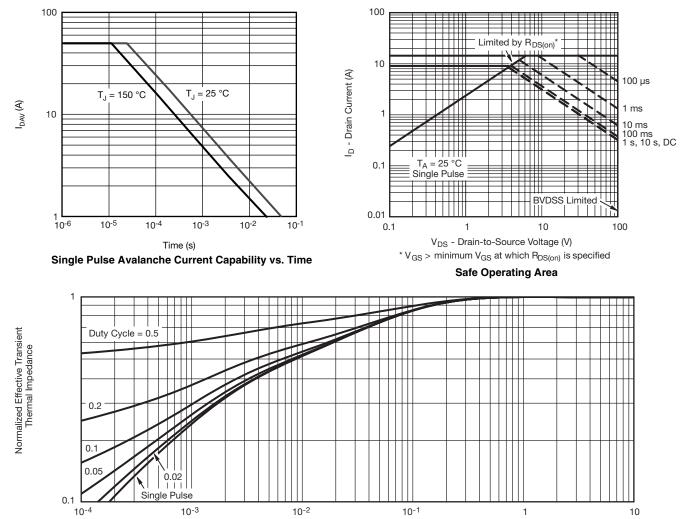








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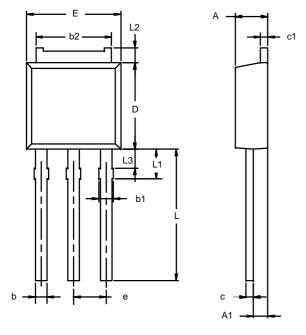


Square Wave Pulse Duration (s) Normalized Thermal Transient Impedance, Junction-to-Case

## **VBFB2102M**



## TO-251AA (DPAK)



Note: Dimension L3 is for reference only.

	MILLIMETERS		INCHES		
Dim	Min	Мах	Min	Max	
Α	2.21	2.38	0.087	0.094	
A1	0.89	1.14	0.035	0.045	
b	0.71	0.89	0.028	0.035	
b1	0.76	1.14	0.030	0.045	
b2	5.23	5.43	0.206	0.214	
С	0.46	0.58	0.018	0.023	
c1	0.46	0.58	0.018	0.023	
D	5.97	6.22	0.235	0.245	
Е	6.48	6.73	0.255	0.265	
е	2.28	BSC	0.090 BSC		
L	3.89	9.53	0.153	0.375	
L1	1.91	2.28	0.075	0.090	
L2	0.89	1.27	0.035	0.050	
L3	1.15	1.52	0.045	0.060	
ECN: S-0 DWG: 53	3946—Rev. E 346	E, 09-Jul-01	•		



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